

# SPECIFICATION FOR LCD MODULE

# MODULE NO: AFS240320TG-2.4-AD10011 REVISION NO: 00

Customer's Approval:

	SIGNATURE	DATE		
PREPARED BY (RD ENGINEER)	YLH	2011-4-1		
CHECKED BY	FR.LI	2011-4-1		
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# **DOCUMENT REVISION HISTORY**

Version	DATE	DESCRIPTION	CHANGED BY
00	Apr-1-2011	First Issue	Ylh

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# 1. Features & Mechanical Specifications

Item	Contents LCD	Unit
LCD Туре	TFT /Transmissive /Normal White	
Viewing direction	6 O' clock	
Backlight	4 Chip White LED in parallel	
Interface	8080-16 parallel bus interface	
Driver IC	HX 8347D	
Outline Dimension	42.72(W) × 60.26(H) × 3.3(T)	mm
Glass area (W×H×T)	40.32×56.26× 1.0	mm
Active area (W×H)	36.72 × 48.96	mm
Number of Dots	240(RGB) × 320	
Dot pitch (W×H)	0.051 × 0.153	mm
Pixel pitch (W×H)	0.153 × 0.153	mm
Operating Temperature	$-20 \sim +70$	°C
Storage temperature	$-30 \sim +80$	°C

## 2. Dimensional O utline

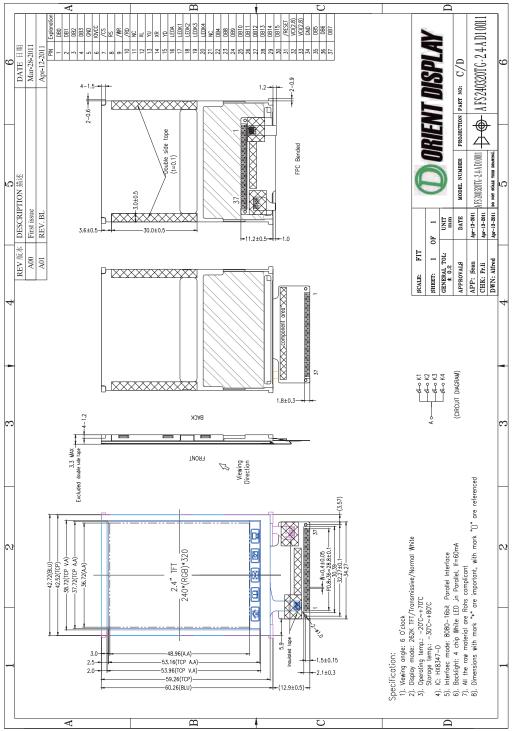


Figure 1. Dimensional outline

# 3. Block Diagram

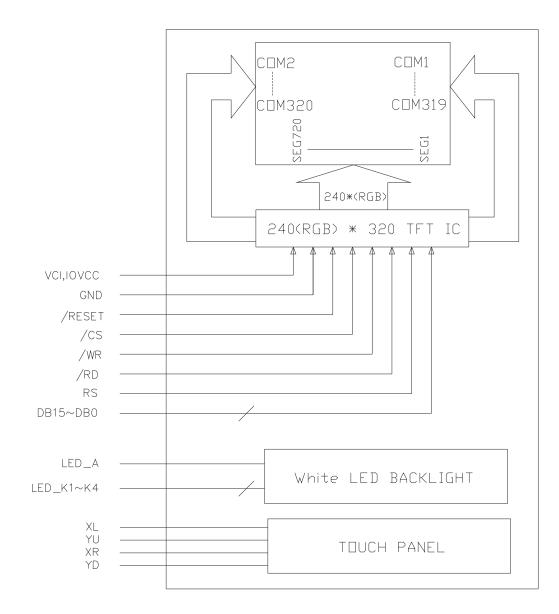


Figure 2. Block diagram

# 4. Pin Description

PIN No.	SYMBOL	Function
1~4	D B 0~ D B 3	D ata B us
5	G N D	G round
6	IO V C C	Digital IO Pad power supply
7	/C S	C hip S elect input pin. (A ctive L ow)
8	RS	D ata or command select pin. "H": D ate, "L": C ommand.
9	/W R	W rite signal input pin. (A ctive Low)
10	/R D	Read signal input pin. (A ctive L ow)
11	N C	No connection
12	ХL	Touch panel XL position
13	ΥU	Touch panel Y U position
14	X R	Touch panel X R position
15	Y D	Touch panel Y D position
16	LED_A	Backlight LED A node
17~20	$L E D K 1 \sim K 4$	Backlight LED Cathode
21	N C	No connection
22	D B 4	D ata B us
23~30	D B 8~ D B 1 5	D ata B us
31	/RESET	Reset pin. (A ctive L ow)
32	VCI	A nalog power supply
33	V C I	A nalog power supply
34	G N D	G round
35~37	D B 5~ D B 7	D ata B us

## 5. A bsolute M aximum R atings

Item	S ymbol	R ating	U nit
Supply V oltage range	V C I	-0.3 to +4.6	V
Supply V oltage range	IOVCC	-0.3 to +4.6	V
0 perating Temperature range	ТОР	-20 to +70	°C
Storage Temperature range	TST	- 30 to + 80	°C

## 6. E lectrical C haracteristics

## **DC C haracteristics**

Item	\$ ymbol	M in.	T ype.	M ax.	U nit
Logic Supply Voltage	VCI	2.3	2.8	3.3	V
Logic Supply Voltage	IOVCC	1.65	1.8	3.3	V

# 7. Backlight C haracteristics

W	hite LED $\times$ 4						$(T a = 25^{\circ}C)$
	Item	S ymbol	C ondition	M in	Тур	M ax	U nit
	Forward Voltage	V F	IF = 60mA	-	3.2	-	V
	Uniformity	$\triangle B p$	-	80	-	-	%
	Luminance for LCD	Lv	IF = 60mA	3500	-	-	cd/m <sup>2</sup>

## 8. E lectro-O ptical C haracteristics

Item		0000000	Orestations	Sp	ecification	าร	Unit	NERES
		Symbol	Conditions	Min.	Typ. Max.		Unit	Note
Transmittance Contrast Ratio Response Time (by Quick)		Τ%		-	5.0	*	%	
		CR	Viewing normal angle	×	250	×		All left side data are based on
		T <sub>on +</sub> T <sub>off</sub>	$\theta_X = \theta_Y = 0^\circ$	-	30	-1	ms	CMI's following condition – 1.LC : TN
Viewing Angle	Hor.	0 <sub>X+</sub>		•	45	•		2.Light Source :CMI LED BLU 3.Film: 日東 NPF TEG 1465DU
	пοι.	0 <sub>x-</sub>	Center CR>10	×	45	*	deg.	4.Machine : DMS 803
	Ver.	Θ <sub>Y+</sub>			45	*		SERVICE AND ADDRESS OF SID
		θγ.		÷	20	×		
	Red	X <sub>R</sub>		0.592	0.612	0.632		
		YR		0.309	0.329	0.349		
	Green	X <sub>G</sub>		0.279	0.299	0.319		
CF only Color	Green	YG	Viewing normal angle	0.547	0.567	0.587		1.Under C light Simulation
Chromaticity (CIE 1931)	Blue	X <sub>B</sub>	$0_X = 0_Y = 0^\circ$	0.124	0.144	0.164		2.NTSC 56%
	Diue	Y <sub>B</sub>		0.090	0.110	0.130		
	White	Xw		0.288	0.308	0.328		
	AALIIIG.	Yw		0.305	0.325	0.345		

\*Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

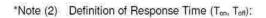
Contrast Ratio (CR) = L63 / L0

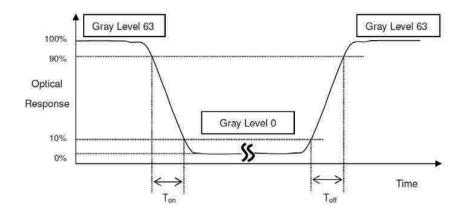
L63: Luminance of gray level 63

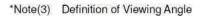
L 0: Luminance of gray level 0

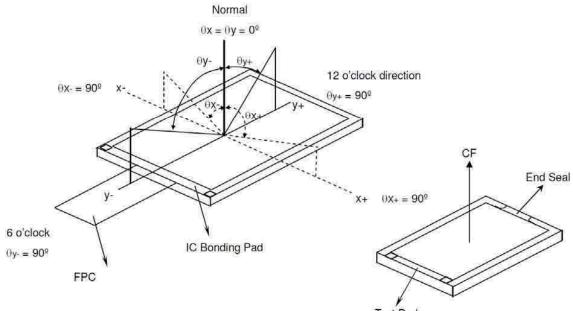
CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (5).





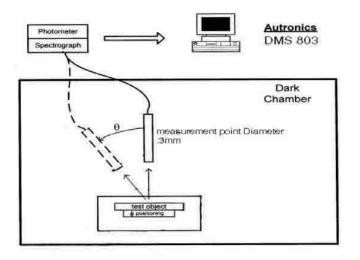




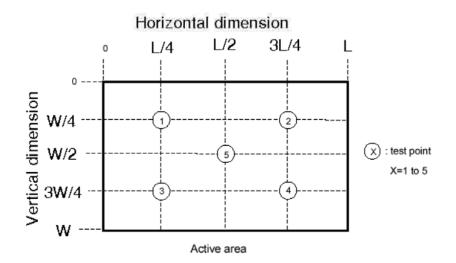
Test Pad

\*Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



\*Note (5)



(Hex)	Operation	W/R	Upper Code	Lower Code							Lower Code					
(11277)	Code		D[17:8]	D7	D6	D5	D4	D3	D2	D1	D0	Comment				
00	Himax ID	R		0	1	0	0	0	1	1	1					
01	Display Mode control	W/R	*	DP_S TB(0)	DP_STB _S(0)	-	1	SCROL (0)	IDMON (0)	INVON (0)	PTLON (0)	<b>a</b> .				
02	Column address start 2	W/R	×			5	SC[15:8] (	8'b0000_00	000)			(æ)				
03	Column address start 1	W/R	2				SC[7:0] (8	зъоооо_оо	00)			<b>3</b> 1.				
04	Column address end 2	W/R				E	EC[15:8] (	8'50000_00	000)			1.78				
05	Column address end 1	W/R	×				EC[7:0] (	в'ь1110_11	11)			:=)				
06	Row address start 2	W/R	4			: 5	SP[15:8] (	8'ьоооо_оо	000)							
07	Row address start 1	W/R				5	SP[7:0] (8	ъ0000_000	000)							
08	Row address end 2	W/R	÷			) E	EP[15:8] (	8'b0000_00	001)			~				
09	Row address end 1	W/R	÷				EP[7:0] (8	3'60011_11	11)			a)				
0A	Partial area start row 2	W/R				P	SL[15:8]	(8'b0000_0	000)			-				
0B	Partial area start row 1	W/R	÷			P	SL[7:0] (8	въоооо_оо	000)							
0C	Partial area end row 2	W/R	-			P	EL[15:8]	(8'b0000_0	001)			- AL				
0D	Partial area end row 1	W/R	ž				PEL[7:0] (	8'b0011_1	11)			÷.,				
0E	Vertical Scroll Top fixed area 2	W/R				т	FA[15:8]	(8'60000_0	000)							
0F	Vertical Scroll Top fixed area 1	W/R	2				TFA[7:0] (	8'60000_00	000)			141				
10	Vertical Scroll	W/R	ž			V	SA[15:8]	(8'b0000_0	001)							
11	height area 2 Vertical Scroll	W/R	-			3	/SA[7:0] (	8'50100_00	000)			:=::				
12	height area 1 Vertical Scroll	W/R	2					(8'60000_0	14446							
13	Button area 2 Vertical Scroll	W/R						8'50000_0								
14	Button area 1 Vertical Scroll	W/R	_97					(8'b0000_0	Markana A							
15	Start address 2 Vertical Scroll	W/R	0	-		14	2 2 5 2 2	8'b0000_0	N.							
16	Start address 1 Memory Access	W/R	<u>ک</u>	MY(0)	MX(0)	MV(0)	ML(0)	BGR(0)	G	-	2					
17	COLMOD	W/R		111111A=1.		)] (4b'0110)		10000	10	PF[2:0] (3b'	-					
18	OSC Control 2	W/R		17		[3:0] (3b'00				)[3:0](4b'01)						
19	OSC Control 1	W/R	2	12	-	-	-		-	-	OSC_E N(0)					
1A	Power Control 1	W/R		191		•	;-	-	1	BT[2:0] (00		80				
1B	Power Control 2	W/R	1	- IÊ				VRH[5:0] (	01_1011)_4	1.8V		(a)				
1C	Power Control 3	W/R		141	147		140	-	1	AP[2:0] (01	1)	141				
1D	Power Control 4	W/R	-	0.÷	I/P	[_FS0[2:0](	100)			FS0[2:0] ]						
1E	Power Control 5	W/R	•	0.84	-	FS1[2:0] ]		•		FS1[2:0] ]		:=/				
1F	Power Control 6	W/R	-	GASEN(1)			PON(0)		XDK(0)	DDVDH_ TRI(0)	STB(1)					
22	SRAM Write Control	W/R					SRAMV	Vrite				•				
23	VCOM Control 1	W/R	÷.				VMF[7:0	(1000_000	0)			<u>.</u>				
24	VCOM Control 2	W/R						](0111_000								
25	VCOM Control 3	W/R					second states of the second states in the second st	](0010_111				(#)				
26	Display Control 1	W/R							ISC[3	:0](0001)						
27	Display Control 2	W/R		and the second second	1:0](10)	PTV	1:0](10)	141	-	PTG(1)	REF(1)					
		A COLORADOR		LITTLA PL	100120-1-07/10-1	GON(1)	DTE(0	0 1000	0] (00)	and the second se	and the second products of the	-				

(Hex)	Operation	W/R	Upper Lower Code									Comme
1998 ann 1	Code	19442	D[17:8]	D7	D6	D5	D4	D3	D2	D1	DO	252000
29	Frame Rate control 1	W/R	120		I/PI_RTN	(3:0)(0010	3:0(0010) N/P_RTN[3:0](0010)					
2A	Frame Rate Control 2	W/R	00	- 24	- I/PL_DIV[1:0](00) - N/P_DIV[1:0](00)							
28	Frame Rate Control 3	W/R	(9)			N/	P_DUM[7:0	0] (86/000	1_1100)			12
2C	Frame Rate Control 4	W/R	(e)			Ĵ/F	-DUM[7:0	000'd8) [(86'000	1_1100)			
2D:	Cycle Control 1	W/R	54				3DON[7:0]					(a)
2E	Oycle Control 2	W/R	172	į	1. 1. 1. 1.		GDOF[7:0]	(8'b0111_	0000)			
2F	Display inversion	W/R	(4)	300	1/P1_	NW[2:0](3	5'001)		N/P	NW[2:0] (3b	(001)	
31	RGB interface control 1	W/R	245	24	*	1.	14	245	14	RCM[1		- SP
32	RGB interface control 2	W/R	(0)	(0)	(*)	2(0)		0PL (0)	HSPL (0)	(0)	EPL (0)	~
33	RGB interface control 3	W/R	261			(a	HE	3P[7:0]				- 14
34	RGB interface control 4	W/R	000	HB	2[8:8]				89[5:0]			
38	Panel Characteristic	W/R	- 397	392		- 392		SS_P anel	GS_Pan el	REV_Pa	BGR_P anel	
38	OTP Control 1	W/R	320	OTP_F	PTM[1:0]	OTP_V	ARDJ[1:0]	POR	OTP_O TPEN	OTP_PP ROG	OTP_P WE	
39	OTP Control 2	W/R	361	- E	1.8	$\geq$		20	OTP_Y A2	OTP_YA1	A0	200
3A	OTP Control 3	W/R		1	14	120	OTP_X A4	ATP_XA3	OTP_X A2	OTP_XA1	OTP_XA0	- 11 -
3C	CABC Control 1	W/R	-			20.20	DBV	7:0](8'h00	1			
3D	CABC Control 2	W/R	1.00	- 22	- 2	BCTRL (0)	60	DD (0)	BL. (0)	Κ		
3E	CABC Control 3	W/R	1.00	1	5	- 24	N.	R	Ø	C1 (0)	(0)	
3F	CABC Control 4	W/R	- 14:2				CMB	7:0](8 h00	£	·		- X
40	r1 Control (1)	W/R	1.5		12	VRP0[5:0] (0'b00_0001)						
41	r1 Control (2)	W/R	1.140		119	VRP1(5:0) (6'b00_1110)						
42	r1 Control (3)	W/R	1.4		1.4	VRP2[5:0] (8'601_0001)						
43	r1 Control (4)	W/R	197		1	VRP3[5.0] (6601 1010)						
44	r1 Control (5)	W/R	585	1	+			VRP4[5:0	6'601_10	06)		100
45	r1 Control (6)	W/R	141	-1-	27 11			VRP5[5:0	1(6'610_01	00)		
48	r1 Control (7)	W/R	1.00						001_0101)	Parties -		
47	r1 Control (8)	W/R	16	AL.		2000	PRP1	[6:0] (7'b	110_0101)			
48	r1 Control (9)	W/R	- 5//	22	- R	11		PK	P0[4:0] (5'b	0_1011)		1
49	r1 Control (10)	W/R	0.0	1.	1.00	- Y-		PK	P1[4:0] (5'b	1_100)		
4A	r1 Control (11)	W/R	110	1	Im			PK	P2[4:0] (5'b	1 1001)		
4B	r1 Control (12)	W/R	12		1007	2+		PK	P314.01 (5'b	1 1010)		~
4C	r1 Control (13)	W/R	V.	12	10	34		PK	P4[4:0] (5b	1 1000)		12
50	r1 Control (14)	W/R		( · · ·	1 - 1		-	VRN0[5:0	1(6'601_10	11)		1.0
51	r1 Control (15)	WIR	-121-	1.0	1			Pupple and physical distances	0 00 010 01	Later and the second		1
52	(1 Control (16)	W/R	14	1	-			Charles and the state of the second	(6610 01	Cash		1.0
53	r1 Control (17)	W/R	41	1.1.4	1.2				(6'b10_11			
54	r1 Control (18)	W/R	947					the prove in the local data	(6'b11_00			14
55	r1 Control (19)	W/R	1.042		P				(6b11_11			
56	r1 Control (20)	W/R	-	1.5			PRNO	فالمرز البران فالموال والتكاليطي الو	001 1010)			1.02
57	r1 Control (21)	W/R	1.80	1.4			and the second second	And in case of the local data in the local data	110 1010)			
58	r1 Control (22)	W/R		-	-				01 (5 60 011	1)		
50	r1 Centrol (23)	W/R	1.21	1					1 (6'60_010			3
5A	r1 Control (24)	W/R							01/5'60 011			
58	r1 Control (25)	W/R	1.1					Number of Street and Street and	0] (5'60_101	- A		
5C	r1 Control (26)	W/R							) (5'b1 010			
50	r1 Control (27)	W/R	4	CGMN1	[1:0] (11)	CGMN0	[1:0](00)		1[1:0](11)	CGMP0	(1:0)(00)	14
60	TE Control	W/R		10			TE_mod e(0)	TEOE(0			Ē	196
E4	Power saving 1	W/R						S1[7.0]				: .
E5	Power saving 2	W/R	141				EQ	S2[7.0]				
E6	Power saving 3	W/R					EQ	53[7:0]				
E7	Power saving 4	W/R	141				EQ	S4[7:0]				100
E8	Source OP control Normal	W/R					OPO	N_N[7 0]				- 2

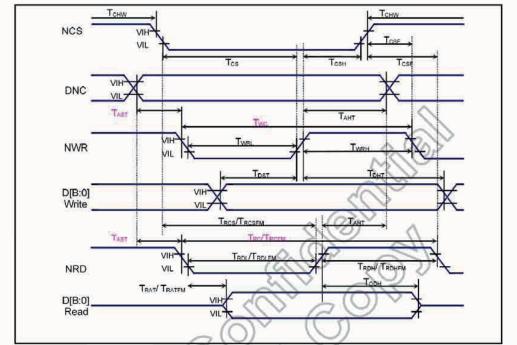
(Hex)	Operation	W/R	Upper Code		Lower Code							Comment
ALCORD !!	Code	8444	D[17:8]	D7	D6	D5	D4	D3	D2	D1	DO	
E9	Source OP control_IDLE	W/R			OPON_[[7:0]							
EA	Power control internal use (1)	W/R	÷		STBA[15:8]							
EB	Power control internal use (2)	W/R	-		STBA[7:0]							
EC	Source control internal use (1)	W/R	2		PTBA[15:8]					e.		
ED	Source control internal use (2)	W/R	-		PTBA[7:0]							
FF	Page select	W/R		-						PAGE_SE	L[1:0] (00)	-

List table of command set page 0

(Hex)	Operation	W/R	Upper Code			Lower Code						
4.0204	Code	10000	D[17:8]	D7	De	D5	D4	D3	D2	D1	DO	
C3	CABC Control 5	W/R	- 14	0	PW	MDIV[2:0]	(000)	- 11	1:	INPLUS (1)	- 11	4
C5	CABC Control 6	W/R	- i -	_	PWM_PERIOD[7:0] (43d)							
C7	CABC Control 7	W/R		083	DIM_FRAME[6:0] (20)							
CB	Gain select register 0	W/R	- A	121	DBG0[6-0](40)					- ¥		
cc	Gain select register 1	W/R	12	120	DBG1[6:0](3C)				2			
CD	Gain select register 2	W/R	1	545	- DBG2[6:0](38)							
CE	Gain select register 3	W/R	*	376	- DBG3(6.0)(34)				*			
CF	Gain select register 4	W/R		5+2	- DBG4[6:0](33)							
DO	Gain select register 5	W/R	*	380	- DBG5[6:0](32)							
DI	Gain select register 6	W/R	*	083	- DBG6(8:0)(28)				× .			
D2	Gain select register 7	W/R	*	343	DBG7[6:0](24)							
D3	Gain select register 8	W/R		(4)	-> DBG8[6:0](22)				- 2			
FF	Page select	W/R	÷		-			199.2	11 .	PAGE_SEL	[1:0] (00)	ů

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## **10. AC Characteristics**



Parallel interface characteristics (8080-series MPU)

Signal	Symbol	Parameter	Min.	Max.	Unit	Description
DNC_SCL	tAST tAHT	Address setup time Address hold time (Write/Read)	0		ns	
NCS	tCHW tCS tRCS tRCSFM tCSF tCSH	Chip select "H" pulse width Chip select setup time (Write) Chip select setup time (Read ID) Chip select setup time (Read FM) Chip select wait time (Write/Read) Chip select hold time	0 15 45 355 10 10		ns	-
NWR_SCL	tWC tWRH tWRL	Write cycle Control pulse "H" duration Control pulse "L" duration	66 15 15		ns	×
NRD(ID)	tRC tRDH tRDL	Read cycle (ID) Control pulse "H" duration (ID) Control pulse "L" duration (ID)	160 90 45	8	ns	When read ID data
NRD(FM)	tRCFM tRDHFM tRDLFM	Read cycle (FM) Control pulse "H" duration (FM) Control pulse "L" duration (FM)	450 90 355	21.18	ns	When read from frame memory
DB17 to DB0	tDST tDHT tRAT tRATEM tODH	Data setup time Data hold time Read access time (ID) Read access time (FM) Output disable time	10 10 - 20	40 340 80	ns	For maximum CL=30pF For minimum CL=8pF

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

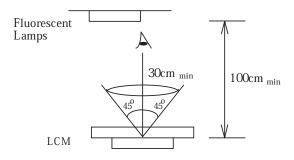
## **<u>11.Quality Specifications</u>**

## All The raw material are Rohs complicant.

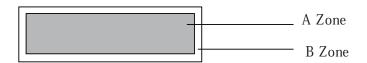
### 11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area

B Zone: outside viewing area

## 11.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	]
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	]
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Defect classification (Note: \* is not including)

## Note on defect classification

No.	Item			Criterion		
1	Short or open circuit			Not allow		
	LC leakage					
	Flickering	•				
	No display					
	Wrong viewing direction					
	Wrong Back-light					
2	Contrast defect		Refer	to approval sar	nple	
	Background color deviation					
3	Point defect, Black spot, dust	Ŷ		Point Size	Acceptable Qty.	
	(including Polarizer)	X	_	¢≤0.10	Disregard	
			-	0.10< ∮≤0.20	3	
	$\phi = (X+Y)/2$		-	0.20< ¢≤0.25 0.25< ¢≤0.30	1	
			-	φ>0.30	0	
			Unit	: mm		
4	Line defect,	<u>→</u> w				
	Scratch	₩ T		Line	Acceptable Qty.	
	Scratch		L	W 0.015≥W	Disregard	
		L	3.0≥1			
			2.0≥1		2	
			1.0≥1		1	
				0.05 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect	
		Unit: mm				
5	Rainbow	Not more than two color changes across the viewing area.				

No	Item	Criterion
6	Chip Remark: X: Length direction Y: Short	X $X$ $X$ $X$ $X$ $X$ $X$ $X$ $X$ $X$
	direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c c} X & Y \\ \hline \\ X & Y \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\$
		$Y \xrightarrow{\bigvee} K$ A cceptable criterion $X  Y  Z$ $\leq 3  \leq 2  \leq t$ shall not reach to ITO
		$W_{\underline{x}} \xrightarrow{Y} \psi$ Acceptable criterion $X \xrightarrow{Y} Z$
		$\begin{array}{c c} & Y \\ & X \\ \hline \\ & X \\ \end{array} \end{array} \xrightarrow{Y} \\ \hline \\ & X \\ & X \\ \hline \\ \\ \\ & X \\ \hline \\ \\ \\ & X \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$

No.	Item	Criterion
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\square < 0.10mm$ is acceptable. $Y \xrightarrow{X} \\ Y \xrightarrow{Y} \\ \downarrow \\ $
8	Back-light	<ol> <li>The color of backlight should correspond its specification.</li> <li>Not allow flickering</li> </ol>
9	Soldering	<ul> <li>(2) Not allow flickering</li> <li>(1) Not allow heavy dirty and solder ball on PCB.</li> <li>(The size of dirty refer to point and dust defect)</li> <li>(2) Over 50% of lead should be soldered on Land.</li> </ul>
10	Wire	<ol> <li>Copper wire should not be rusted</li> <li>Not allow crack on copper wire connection.</li> <li>Not allow reversing the position of the flat cable.</li> <li>Not allow exposed copper wire inside the flat cable.</li> </ol>
11*	PCB	<ul><li>(1) Not allow screw rust or damage.</li><li>(2) Not allow missing or wrong putting of component.</li></ul>

No	Item	Criterion
12	Protruded W: Terminal Width	$W_{\underline{N}}$ $W_{\underline{N}}$ V = 0.4 Acceptable criteria: $Y \le 0.4$
13	ТАВ	1. Position H H TAB W = W1 ITO $W1 \le 1/3W$ $H1 \le 1/3H$
		2 FPC bonding strength test F F FPC P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	<ul> <li>A. Zone</li> <li>Maximum 2 minor non-conformities per one unit.</li> <li>Defect distance: each point to be separated over 10mm</li> <li>B. Zone</li> <li>It is acceptable when it is no trouble for quality and assembly in customer's end product.</li> </ul>

## 11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	No abnormalities
Low temp. Operating	-20°C	48	in functions
Humidity	60°C/ 90%RH	48	and appearance
Temp. Cycle	$-30^{\circ}C \leftarrow 25^{\circ}C \rightarrow 80^{\circ}C$	10cycles	
	$(60 \min \leftarrow 5 \min \rightarrow 60\min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $20\pm8^{\circ}$ C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

## 11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting ORIENT DISPLAY.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature:  $280^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

### **Limited Warranty**

ORIENT DISPLAY LCDs and modules are not consumer products, but may be incorporated by OD's customers into consumer products or components thereof, OD does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of OD is limited to repair or replacement on the terms set forth below. OD will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between OD and the customer, OD will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with OD general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.